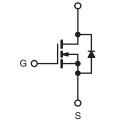
Vishay Siliconix



E Series Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.158			
Q _g max. (nC)	95				
Q _{gs} (nC)	16				
Q _{gd} (nC)	25				
Configuration	Single				





N-Channel MOSFET

FEATURES

- Low Figure-of-Merit (FOM) Ron x Qa
- Low Input Capacitance (C_{iss})
- Reduced Switching and Conduction Losses
- Ultra Low Gate Charge (Qg)
- Avalanche Energy Rated (UIS)
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- · Server and Telecom Power Supplies
- Switch Mode Power Supplies (SMPS)
- Power Factor Correction Power Supplies (PFC)
- Lighting
 - High-Intensity Discharge (HID)
 - Fluorescent Ballast Lighting
- Industrial
 - Welding
 - Induction Heating
 - Motor Drives
 - Battery Chargers
 - Renewable Energy
 - Solar (PV Inverters)

ORDERING INFORMATION	
Package	TO-247AD
Lead (Pb)-free and Halogen-free	SiHW23N60E-GE3

ABSOLUTE MAXIMUM RATINGS (T _C :	= 25 °C, unless otherwi	se noted)			
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V _{DS}	600			
Gate-Source Voltage			± 20	V	
Gate-Source Voltage AC (f > 1 Hz)	V _{GS} –	30	1		
Continuous Drain Current (T _J = 150 °C)	$T_{\rm C} = 25 ^{\circ}{\rm C}$	1	23		
	V_{GS} at 10 V $T_C = 100 \text{ °C}$	ID	15	А	
Pulsed Drain Current ^a	I _{DM}	63	1		
Linear Derating Factor			1.8	W/°C	
Single Pulse Avalanche Energy ^b	E _{AS}	353	mJ		
Maximum Power Dissipation	PD	227	W		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 150	°C	
Drain-Source Voltage Slope	T _J = 125 °C		37	V/ns	
Reverse Diode dV/dtd		dV/dt	34	V/IIS	
Soldering Recommendations (Peak Temperature) ^c	for 10 s		300	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 5 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, dI/dt = 100 A/µs, starting T_J = 25 °C.

S13-1031-Rev. A, 10-Jun-13

1



RoHS

COMPLIANT HALOGEN

FREE



Vishay Siliconix

PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R _{thJA}	- 40				°C AM		
Maximum Junction-to-Case (Drain)	R _{thJC}	- 0.55				°C/W		
		·						
SPECIFICATIONS (T _J = 25 °C, u	nless otherwi	ise noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNI
Static					<u>. </u>		Į	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 2	250 µA	600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	$I_D = 1 \text{ mA}$	-	0.72	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$		2	-	4	V	
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 20 V$		-	-	± 100	nA	
, i i i i i i i i i i i i i i i i i i i		V _{DS} = 600 V, V _{GS} = 0 V		-	-	1	+	
Zero Gate Voltage Drain Current	I _{DSS}	-	$V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$		-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V		$_{\rm D} = 12 {\rm A}$	-	0.132	0.158	Ω
Forward Transconductance	g _{fs}	<u></u>	= 30 V, I _D =		-	6.4	-	S
Dynamic	010					I	I	I
Input Capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz $V_{DS} = 0 V \text{ to } 480 V, V_{GS} = 0 V$		-	2418	-	pF	
Output Capacitance	C _{oss}			-	119	-		
Reverse Transfer Capacitance	C _{rss}			-	4	-		
Effective Output Capacitance, Energy Related ^a	C _{o(er)}			-	107	-		
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	320	-		
Total Gate Charge	Qg			-	63	95	nC	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	V _{GS} = 10 V I _D = 12 A, V _{DS} = 480 V		-	16		-
Gate-Drain Charge	Q _{gd}				-	25		-
Turn-On Delay Time	t _{d(on)}			-	22	44		
Rise Time	t _r	V _{DD} =	V_{DD} = 480 V, I_D = 12 A, V_{GS} = 10 V, R_g = 9.1 Ω		-	38	76	ns
Turn-Off Delay Time	t _{d(off)}	V _{GS} =			-	66	99	
Fall Time	t _f			-	34	68		
Gate Input Resistance	R _g	f = 1 MHz, open drain		-	0.73	-	Ω	
Drain-Source Body Diode Characteristic	s					-		
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	23	A	
Pulsed Diode Forward Current	I _{SM}			-	-	63		
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 12 A, V _{GS} = 0 V		-	0.9	1.2	V	
Reverse Recovery Time	t _{rr}	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 12 \text{ A},$ $dl/dt = 100 \text{ A}/\mu\text{s}, V_{R} = 25 \text{ V}$		-	384	768	ns	
Reverse Recovery Charge	Q _{rr}			_	6.4	12.8	μ	
Reverse Recovery Current	I _{RRM}			-	30		A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

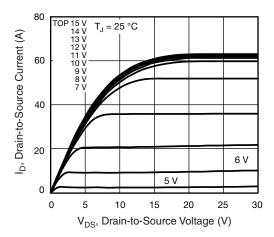


Fig. 1 - Typical Output Characteristics

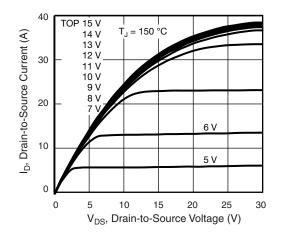


Fig. 2 - Typical Output Characteristics

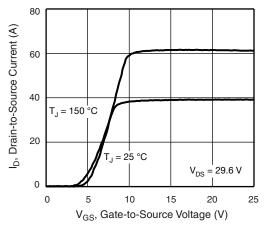


Fig. 3 - Typical Transfer Characteristics

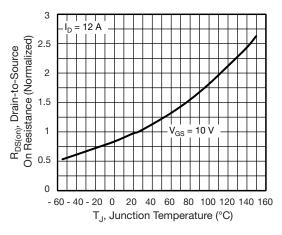


Fig. 4 - Normalized On-Resistance vs. Temperature

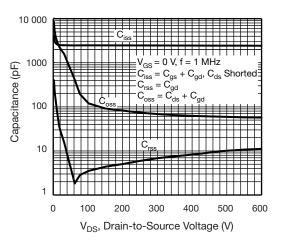


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

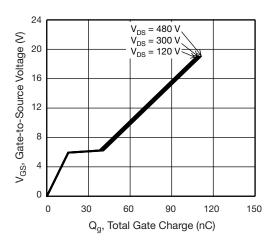
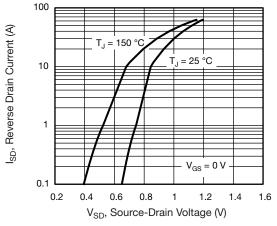


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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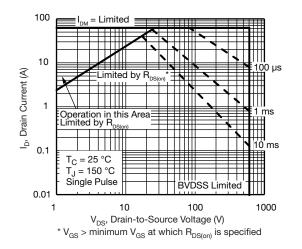


Fig. 8 - Maximum Safe Operating Area

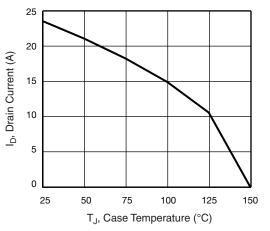


Fig. 9 - Maximum Drain Current vs. Case Temperature

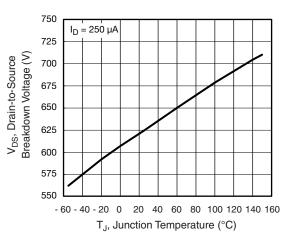
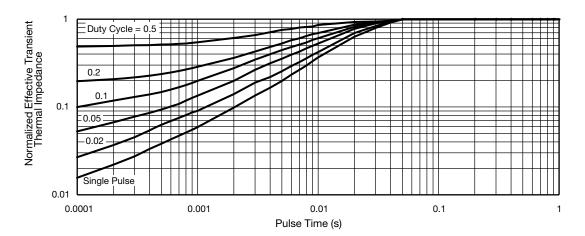


Fig. 10 - Temperature vs. Drain-to-Source Voltage





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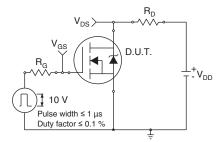


Fig. 12 - Switching Time Test Circuit

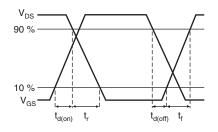


Fig. 13 - Switching Time Waveforms

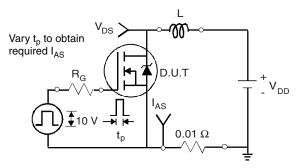


Fig. 14 - Unclamped Inductive Test Circuit

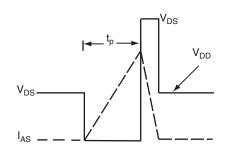
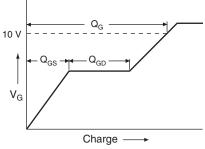


Fig. 15 - Unclamped Inductive Waveforms



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Fig. 16 - Basic Gate Charge Waveform

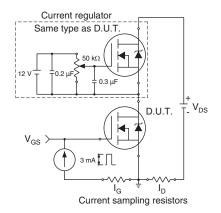


Fig. 17 - Gate Charge Test Circuit

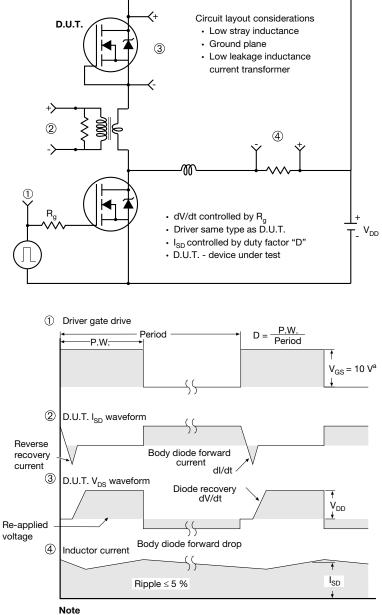
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 18 - For N-Channel

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